



0.2A SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (mA)	V _{FMAX} (V) @100mA	I _{RMAX} (μ A)
30	200	0.70	0.4

Description

The SDM02M30CLP3 is a Schottky barrier diode optimized for low forward voltage drop and very-low reverse leakage current in a common cathode DFN package. Encapsulated in the small DFN1006 with footprint of 0.6mm² and ultra-low package profile, this device is designed for saving PCB space in portable electronic devices.

Applications

- Portable Device
- Mobile Applications
- LCD and Keypad Backlighting
- Clamping Protection
- Reverse Voltage and Current Protection
- Freewheeling Diode

Features and Benefits

- Small Leadless Surface Mount Package (1.0mm x 0.6mm x 0.37mm)
- Very Low Reverse Leakage Current
- Low Forward Voltage
- Fast Reverse Recovery
- Low Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

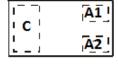
Mechanical Data

- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish—NiPdAu Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 4
- Weight: 0.001 grams (Approximate)

X2-DFN1006-3



Bottom View



Top View C: Cathode A1&A2: Anode 1&2



Equivalent Circuit

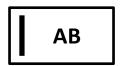
Ordering Information (Note 4)

Part Number	Case	Packaging
SDM02M30CLP3-7B	X2-DFN1006-3	10,000/Tape & Reel

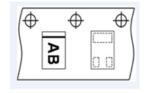
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



AB = Product Type Marking Code AB = LC or LC Bar Denotes Cathode Side





Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Output Current (Total)	lo	200	mA
Non-Repetitive Peak Forward Surge Current (8.33ms Half-Sine Waveform, per Diode)	I _{FSM}	2	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation(Note 5) (Total)	Pd	350	mW
Typical Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\Theta JA}$	350	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

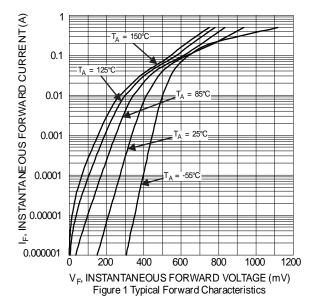
Electrical Characteristics (@T_A = +25°C, per diode unless otherwise specified.)

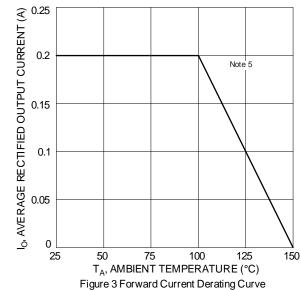
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage	VF	_	0.28 0.34 0.42 0.63	0.34 0.40 0.48 0.70	V	I _F = 0.1mA I _F = 1mA I _F = 10mA I _F = 100mA,
Leakage Current (Note 6)	I _R	_	0.014 0.040	0.15 0.40	μΑ	$V_R = 10V$ $V_R = 30V$
Reverse Recovery Time	t _{RR}	_	2	1	ns ns	$I_F = 10\text{mA}, I_R = 10\text{mA},$ $I_{RR} = 1\text{mA}$
Total Capacitance	Ст	_	3.3		pF	$V_R = 5.0V_{DC}$, $f = 1MHz$

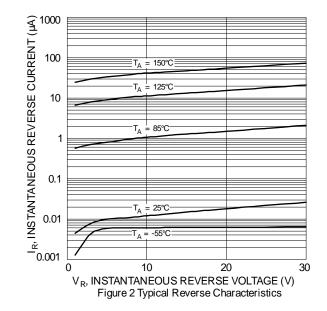
Notes:

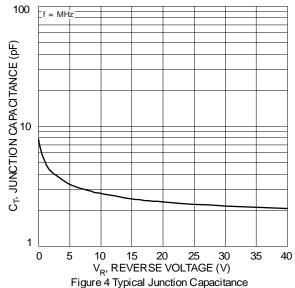
^{5.} Part mounted on FR-4 PCB with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html. 6. Short duration pulse test used to minimize self-heating effect.









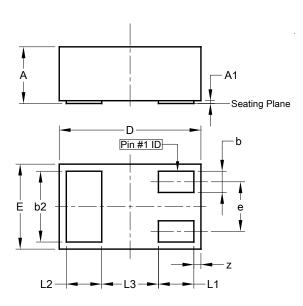




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

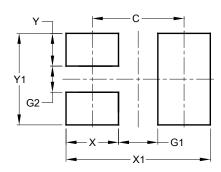


X2-DFN1006-3				
Dim	Min	Max	Тур	
Α	_	0.40		
A1	0.00	0.05	0.03	
b	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
D	0.95	1.05	1.00	
Е	0.55	0.65	0.60	
е	ı	1	0.35	
L1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3	-	-	0.40	
Z	0.02	0.08	0.05	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



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